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Bib Data Sheet

CONFIRMATION NO. 6113

SERIAL NUMBER 10/623,772	FILING DATE 07/22/2003 RULE	CLASS 438	GROUP ART UNIT 2813	ATTORNEY DOCKET NO. 402715
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** CONTINUING DATA ***** *EK (none)*

** FOREIGN APPLICATIONS ***** *EK*

JAPAN 2002-274300 09/20/2002 ✓
 JAPAN 2003-033316 02/12/2003 ✓

IF REQUIRED, FOREIGN FILING LICENSE GRANTED
 ** 02/27/2004

Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no	STATE OR COUNTRY JAPAN	SHEETS DRAWING 3	TOTAL CLAIMS 14	INDEPENDENT CLAIMS 3
35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged <i>EK</i> Examiner's Signature Initials				

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TITLE
 Via-filling material and process for fabricating semiconductor integrated circuit using the material

FILING FEE RECEIVED 1254	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit
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